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SPECIFICATION

Device Name :

IGBT-IPM

Type Name

6MBP15RY060

Spec. No.

MS6M0362

Fuji Electric Co.,Ltd.

Matsumoto Factory

| | DATE | NAME | APPROVED | Fuji Electric Co.,Ltd. |
|------------------|------|---------|--------------|------------------------|
| DRAWN CHECKED | | Mishiwa | S. Kebawashi | ON MS6M0362 1/11 A C C |

H04-004-07

Revised Record

Applied Ind. Content Drawn Checked Approved Date Classification Date JUL-13 issued Enactment Date Addition, packing spec. 1/11/Sep. -29 Revision α Raisson, at time 3/11 198 - 98 Rayision, Toc Addition, plating space Correction, smorts in uniting NOV. - 10 NOV. -10 - 98 Revision Revision : size of packing box Feb->3 Revision C - 99 199 Correction: Briefs in writing

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3. Maximum Ratings (最大定格)

(Tc=25°C unless otherwise specified)

| ltem | s | Symbols | Ratings | Unit |
|--|-----------------------------|---------------|----------|------|
| DC Bus Voltage | | VDC | 450 | V |
| DC Bus Voltage (surge) | | VDC(surge) | 500 | V |
| DC Bus Voltage (short operating) | Vsc | 400 | V | |
| Collector-Emitter Voltage | | VCES | 600 | V |
| Collector Current | DC | Ic | 15 | А |
| | 1 ms | ICP | 30 | А |
| | Duty=44.1% | -lc | 15 | Α |
| llector Power Dissipation One Transistor | | Pc | 40 | Ŵ |
| Junction Temperature | | Τj | 150 | ိင |
| Input Voltage of Power Supply for | r Pre-Driver | Vcc | -0.3~20 | V |
| Input Signal Current | | lin | 20 | mA |
| Alarm Signal Voltage | | VALM | Vcc | V |
| Alarm Signal Current | - | IALM | 15 | mA |
| Storage Temperature | | Tstg | -40~125 | °C |
| Operating Case Temperature | Тсор | -20~100 | °C | |
| Isolating Voltage (Terminal to bas | se,50/60Hz sine wave 1min.) | Viso | AC 2500 | V |
| Screw Torque | | Mounting (M4) | 2.0 | N•m |

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4.1 Electrical Characteristics of Power Circuit (主回路部電気的特性)

(Tj=Tc=25°C, Vcc=15V)

| Items | Symbols | Conditions | min. | typ. | max. | Unit |
|---------------------------------------|----------|-------------------|----------|------|------|------|
| Collector Current at off Signal Input | ICES | VCE=600V, lin=0mA | - | _ | 1.0 | mA |
| Collector-Emitter Saturation Voltage | VCE(sat) | IC=15A, lin=10mA | <u>-</u> | - | 2.7 | ٧ |
| Forward Voltage of FWD | VF | -IC=15A, lin=0mA | - | - | 3.5 | ٧ |

4.2 Electrical Characteristics of Control Circuit (制御部電気的特性)

(Ti=Tc=25°C, Vcc=15V)

| | | | (⊤j≃T | c=25°C, | Vcc=15 | V) | . 1 |
|--|------------|------------------------|-------|---------|--------|------|-------------|
| ltems | Symbols | - Conditions | min. | typ. | max. | Unit | |
| Power Supply Current of P-line Pre-driver (one unit) | ICCP | lin=0mA, | 1 | 2.0 | 5.0 | mA | |
| Power Supply Current of N-line Pre-driver | ICCN | lin=0mA, | - | 4.0 | 10.0 | mA | |
| Input Signal Threshold Current | lin(th) | Turn-on | - | 1.8 | 2.3 | mA | |
| | | Turn-off | 0.8 | 1.3 | - | mA | |
| Hysteresis of Input Signal Theshold Current | linH | - | - | 0.5 | - | mA | |
| Input Signal Saturation Voltage | Vin(sat) | lin=20mA | | 0.8 | 2.0 | V | |
| Over Heating Protection(過熱保護) | | | | | | | |
| IGBT chips Over HeatProtection Temperature Level | Тјон | Surface of IGBT | 150 | - | - | °C | |
| Hysteresis | Тјн | - | _ | 20 | _ | °C | |
| Over Current Protection(過電流保証 | E) | | | | | | |
| Collector Current Protection Level | loc | N-side, (N1-N2 open) | 18 | 22 | 26 | Α | (b) |
| | Voc | Between N1 and N2 | 190 | 200 | 210 | mV | |
| OC detecting resistance value | Roc | | - | 9.0 | _ | mΩ | |
| Protection Delay time | tDOC | Tj=25°C Fig. 1, Fig. 2 | _ | 5.0 | 7.0 | μs | |
| Power Supply Under Voltage Protection | on (電源電E | E低下保護) | | | • | | |
| Under Voltage Protection Level | Vuv | - | 11.0 | - | 12.5 | V | |
| Hysteresis | Vн | - | 0.2 | _ | 0.8 | V | |
| Alarm Signal Output (アラーム信号出 | カ) | | | | | | |
| Alarm Signal Hold Time | tALM | - | 1.0 | 2.0 | - | ms | |

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5. Switching Characteristics (スイッチング特性)

(Tj=Tc=25°C, Vcc=15V)

| Items | Symbols | Conditions | min. | typ. | max. | Unit |
|-----------------------|---------|------------------------|------|------|------|------|
| Switching Time (IGBT) | ton | lc=15A, VDC=300V | 0.5 | - | - | ire |
| | toff | lin=10mA | - | _ | 5.0 | μs |
| Switching Time (FWD) | trr | Inductive-Load, Fig. 3 | _ | _ | 0.5 | μs |

6. Thermal Characteristics (熱特性)

(Tj=Tc=25°C, Vcc=15V)

| Items | | Symbols | min. | typ. | max. | Unit |
|--|------|----------|------|------|------|------|
| Junction to Case Thermal | IGBT | Rth(j-c) | _ | - | 3.1 | °C/W |
| Resistance | FWD | Rth(j-c) | - | - | 5.4 | °C/W |
| Case to Fin Thermal Resistance with Compound | | Rth(c-f) | - | 0.05 | - | °C/W |

7. Recommendable Value (推奨値)

| Items | Symbols | Conditions | min. | typ. | max. | Unit | |
|---|---------|--------------|------|------|------|------|-----|
| DC Bus Voltage | VDC | - | 200 | - | 400 | V | |
| Operating Power SupplyVoltage Range of Pre-drive | Vcc | - | 13.5 | 15 | 16.5 | ٧ | |
| Input Signal Current | lF | CTR=100~200% | 8 | - | 10 | mA | (P) |
| Switching Frequency | fsw | - | 1 | 3 | 5 | kHz | |
| Flatness of heat sink | | - | -100 | - | 100 | imu | |
| Mounting Screw Torque (M4) | | - | 1.3 | - | 1.7 | N·m | |

8. Weight (重量)

| Items | Symbols | Conditions | min. | typ. | max. | Unit |
|--------|---------|------------|------|------|------|------|
| Weight | _ | - | - | 50 | - | g |

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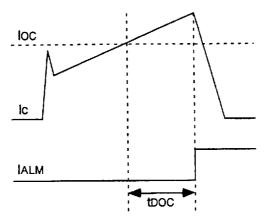


Fig. 1. Definition of OC protection delay time (過電流保護遅れ時間の定義)

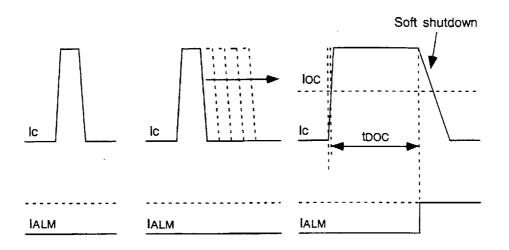


Fig. 2. Definition of protection delay time at short circuit (短絡時保護遅れ時間の定義)

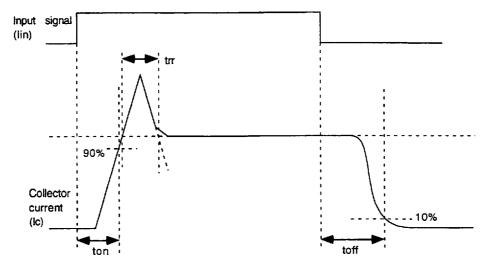


Fig. 3. Definition of switching time (スイッチング時間の定義)

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10. Application Guideline (適用時の注意事項)

- The wiring between the opto-couplers and the input terminals of the IPM should be as short as possible. The stray capacitance between primary and secondary side of the opto-couplers should not be increased by pattern lay-out of the control circuits.

フォトカプラと PMの入力端子間配線はできるだけ短くし、フォトカプラの1次・2次間の浮遊 容量を増加させないパターンレイアウトとしてください。

- Capacitors should be connected between Vcc and GND terminals of the opto-coupler as closely as possible.

フォトカプラのV∞-GND間には、コンデンサをできるだけ近接して取り付けてください。

- Each power supplies for drive circuits should not have transient voltage fluctuation. Four power supplies which are isolated should be applied individually.

各制御電源は瞬時電圧変動の少ない、絶縁されたものを4個独立に使用してください。

- In order to prevent noise from AC line, connect capacitor (approx. 4.7nF) between three-phase line and earth.

ACラインからのノイズの侵入を防ぐため、3 相各線―アース間に4.7nF程度のコンデンサを接続 _ してください。

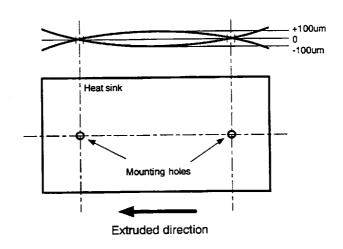
- Do not connect N2-terminal of main circuit to ground (GND) of the control circuit.

入力回路のグランド (GND)と主回路N2端子を接続しないでください。

11. Heat sink mounting precautions (IPMの取り付け方法)

- A mounting surface of a heat sink should be finished to a roughness below $10\mu m$ and a flatness between screw holes below $100\mu m$. If the flatness is below - $100\mu m$, a thermal resistance between an IPM and a heat sink is increased. If the flatness is over + $100\mu m$, there is the danger of the isolation failure.
- IPMを取り付けるヒートシンク面の仕上げは、粗さ10 μ m以下、ネジ位置間での面の平坦度 (反り)100 μ m以内にして下さい。平坦度が -100μ m以下の場合、ヒートシンクへの接触熱抵抗が増加します。また、平坦度が $+100\mu$ m以上の場合、絶縁破壊を起こす危険性があります。
- Apply a thermal compound between an IPM and a heat sink to reduce a contact thermal resistance. 接触熱抵抗を小さくするために、IPMとヒートシンクの間にサーマルコンパウンドを塗布して下さい。
- Mount an IPM in parallel with extruded direction of a heat sink to reduce an influence of a change of a heat sink, when a heat sink which is made by an extruder is applied.

押し出し機によって作られたヒートシンクを使用する場合は、ヒートシンクの変形の影響を小さくするために P Mをヒートシンクの押し出し方向と平行に取り付けて下さい。

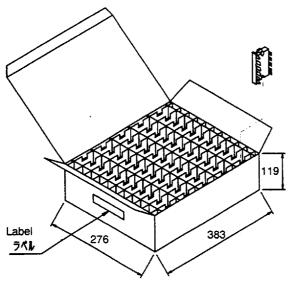


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Material : Corrugated cardbord

材料 ダンボール

Weight: Approx. 3.1kg (max.)

重量 約3.1kg (最大)
Quantity : 50pcs (max.)
数量 50個 (最大)



13. Storage and transportation notes (保管、運搬上の注意事項)

- The IGBT-IPM should be stored at a standard temperature of 5 to 35℃ and humidity of 45 to 75%. 室内で常温常湿保存が望ましい。(5 ~3 5 ℃、4 5 ~7 5 %)
- Store modules in a place with few temperature changes in order to avoid condensation on the module surface.

急激な温度変化がないこと。(モジュール表面が結露しないこと)

- Avoid exposure to corrosive gases and dust.

腐食性ガスの発生場所、塵埃の多い場所は避けること。

- Avoid excessive external force on the modules.

半導体製品に荷重がかからないように注意すること。

- Store modules with unprocessed terminals.

モジュールの端子は未加工の状態で保管すること。

- Don't drop and shock the modules during transportation.

運搬時に衝撃を与えたり落下させないこと。

14. Operation environment (使用環境)

- Avoid exposure to corrosive gases. 腐食性ガスの雰囲気での使用は避けること。

15. Applicable category(適用範囲)

- This specification is applied to the IGBT-IPM named 6MBP15RY060. 本仕様書は、IGBT-IPM(型式: 6MBP15RY060)に適用する。

